## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re: Gerald H. Negley et al. Application Serial No.: 10/659,108 Confirmation No.: 4336 Group Art Unit: 2814

Filed: September 9, 2003

Examiner: Thao X. Le

For: SOLII

SOLID METAL BLOCK MOUNTING SUBSTRATES FOR SEMICONDUCTOR LIGHT EMITTING DEVICES, AND OXIDIZING METHODS FOR FABRICATING

**SAME** 

October 29, 2004

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

## SECOND SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT PURSUANT TO 37 C.F.R. § 1.97(b)

Sir:

Attached is a form PTO-1449, together with a copy of each listed document. This Information Disclosure Statement is submitted in accordance with 37 C.F.R. §1.97(b), within three months of the filing date of the above-referenced application or before the mailing of a first Office Action on the merits, whichever event occurs last. Therefore, no fee is believed due. However, the Commissioner is hereby authorized to charge any deficiency or credit any overpayment to Deposit Account No. 50-0220.

Respectfully submitted,

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I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22312/1450 on October 29, 2004.

Susan E. Freedman

Date of Signature: October 29, 2004

Substitute form 1449A/PTO			T D	Complete if Known		
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Examiner Signature	<del></del>	Date Considered	